

filed on 2/6/2007.

Patent No.	Issue Date	First Named Inventor
6,101,164	2000-08-08	Kado

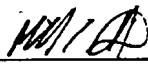
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This filing is not intended to represent that the above listed patent, publications and articles are material to patentability as defined in 37 C.F.R. §1.56. Rather, Applicant does not believe that the listed patent, publications and articles affects the patentability of the claims in the above captioned application. However, Applicant offers that the references, though cumulative and not considered to be of particular relevance, may fall under the duty of disclosure; therefore, Applicant is filing this IDS. Applicant understands that the IDS will not be considered, but will be placed in the application file.

No fee is believed due in connection with this paper. However, the Commissioner is authorized to charge any underpayment or credit any overpayment to Deposit Account No. 06-1325 for any matter in connection with this response, including any fee for extension of time, which may be required.

Respectfully submitted,


Date: 02/06/2007

By: 

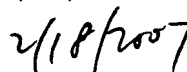
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Form PTO-1449 (Substitute) Information Disclosure Statement BY APPLICANT (Use several sheets if necessary)	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	Attorney Docket Number LAZE-01000US0	Application/Patent Number 09/465,592
	Applicant/Patent Owner Culver et al.		
	Filing/Issue Date 12/17/99	Group Art Unit 2653 2627	

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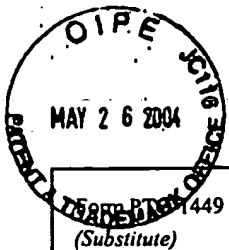
Examiner Initial	Application Number	Filing Date	First Named Inventor	Petition to Expunge? Yes No

PENDING U.S. PATENT APPLICATIONS					
Examiner Initial		Application Number	Filing Date	First Named Inventor	Petition to Expunge?
					Yes

FOREIGN PATENT DOCUMENTS								
Examiner Initial		Document Number	Publication Date	Country	Class	Subclass	Translation	
							Yes	No

OTHER DOCUMENTS (Include author (if any), title, publisher and place of publication, date and pertinent pages)		

Examiner <i>Kim Chun</i>	Date Considered <i>2/21/2007</i>
<p>*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</p>	
<p>*1 = Copy not submitted because it was submitted in prior application SN __/__, filed ____, 20__, relied on under 35 USC §120.</p>	
<p>**2 = Copy not submitted because it was submitted in prior application SN __/__, filed ____, 20__, relied on under 35 USC §120.</p>	



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5,097,443 (Substitute) Information Disclosure Statement BY APPLICANT (Use several sheets if necessary)	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE	Attorney Docket Number LAZE-01000US0 SRM/MLR	Serial/Patent Number 09/465,592
		Applicant/Patent Owner Culver; Rust	
	Filing/Issue Date 12/17/1999	Group Art Unit 2653 2627	

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Examiner Initial		Patent Number	Issue Date	First Named Inventor	Class	Subclass	Filing Date
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lc	2	5,335,197	08/02/94	Kaneko et al.	365	153	12/10/91
lc	3	5,389,475	02/14/95	Yanagisawa et al.	430	019	06/18/92
lc	4	5,446,684	08/29/95	Kaneko et al.	365	046	05/10/94
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lc	6	5,557,596	09/17/96	Gibson et al.	369	101	07/12/95
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Examiner Initial		Patent Application Publication Number	Publication Date	Applicant
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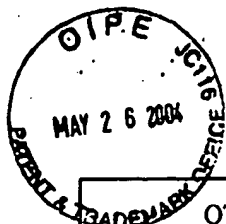
Examiner Initial		Application Number	Filing Date	First Named Inventor	Petition to Expunge? Yes No

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Examiner Initial		Document Number	Publication Date	Country	Class	Subclass	Translation Yes No
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lee	22	JP3295043	12/26/91	JAPAN			X
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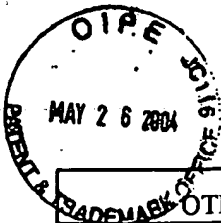
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Examiner <u>Kim Chun</u>		Date Considered <u>2/21/2007</u>
*EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.		
*1 = Copy not submitted because it was submitted in prior application SN <u>/</u> , filed <u></u> , 20 <u></u> , relied on under 35 USC §120.		
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